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Attorney Docket No. 1061

PATENT

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

The patent application of

Inventor(s): AMAGAI et al

For: LEAD-FREE SOLDER

is attached for filing.

- [X] This application is being filed without a declaration or fee.
- [X] This application claims the priority of Japanese Patent Application No. 2003-112287 filed on April 17, 2003.

Respectfully submitted,

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